

Discovery kit with STM32WB5MMG module

Introduction

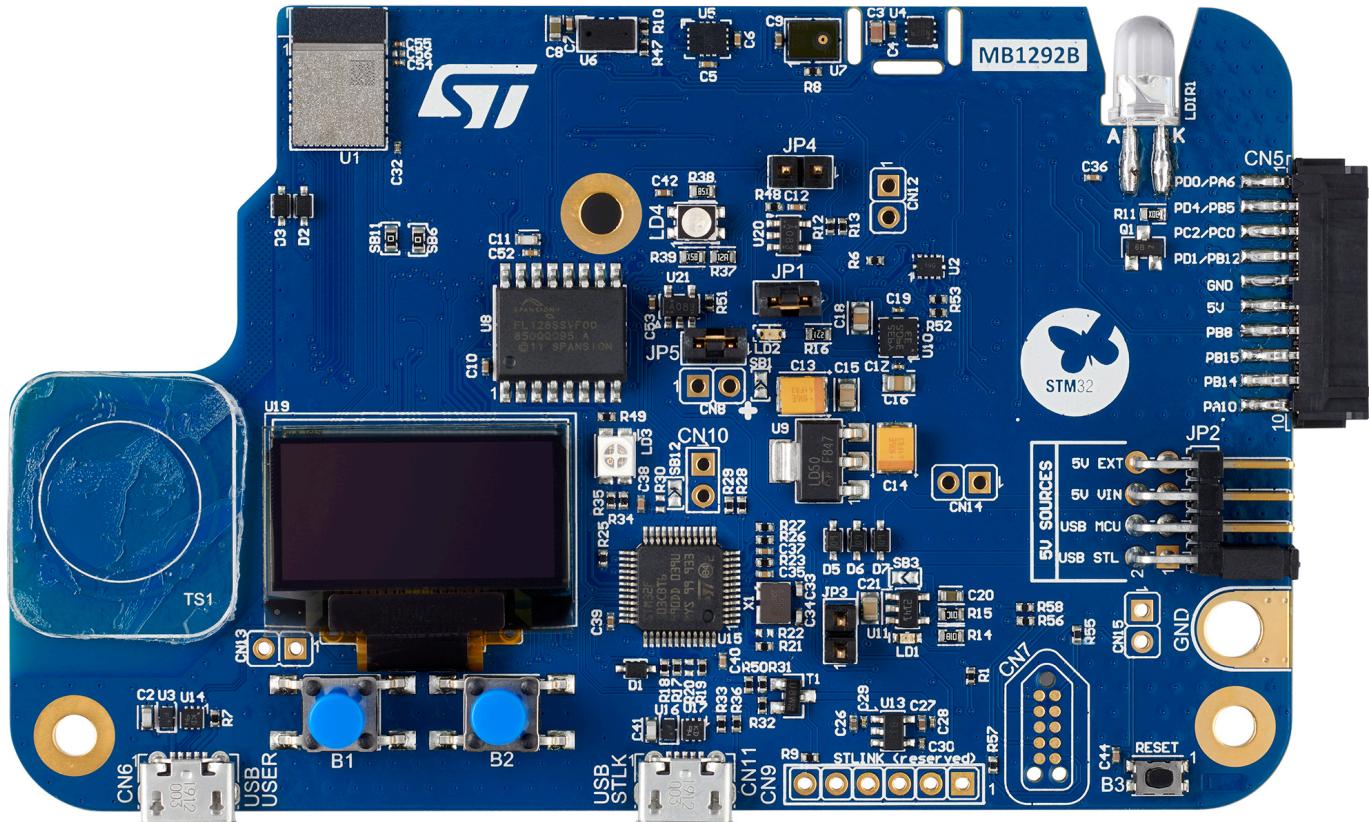
The [STM32WB5MM-DK](#) Discovery kit is designed as a complete demonstration and development platform for the STMicroelectronics [STM32WB5MMG](#) module based on the Arm® Cortex®-M4 and Arm® Cortex®-M0+ cores.

The STM32 device is a multi-protocol wireless and ultra-low-power device embedding a powerful and ultra-low-power radio compliant with the Bluetooth® Low Energy (BLE) SIG specification v5.2 and with IEEE 802.15.4-2011.

The hardware features of the Discovery kits are available for users to develop their applications: Audio, USB, user buttons, and Bluetooth® Low Energy. Extension connectors allow easy connection of an ARDUINO® board for a specific application.

An ST-LINK/V2-1 is integrated on the board, as an embedded in-circuit debugger and programmer for the STM32 MCU and the USB Virtual COM port bridge.

Figure 1. STM32WB5MM-DK Discovery kit



Picture is not contractual.

1 Features

- STM32W5MMG (1-Mbyte Flash memory, 256-Kbyte SRAM, in Module RF package)
 - Dual-core 32-bit (Arm® Cortex®-M4 and dedicated M0+ CPU for real-time radio layer)
 - 2.4 GHz RF transceiver supporting Bluetooth® specification V5.2, 802.15.4 with Zigbee®, Thread®, and proprietary protocols
- 0.96-inch 128×64 OLED display
- 128-Mbit Quad-SPI NOR Flash Memory
- Temperature sensor
- Accelerometer/gyroscope sensor
- Time-of-Flight and gesture-detection sensor
- Digital microphone
- RGB LED
- Infrared LED
- 3 push-buttons (2 users and 1 reset) and 1 touch key button
- Board connectors:
 - STMod+
 - ARDUINO® Uno V3 expansion connector
 - USB user with Micro-B connector
 - TAG10 10-pin footprint
- Flexible power-supply options: ST-LINK/V2-1 USB connector, 5 V delivered by ARDUINO® or external connector, USB charger, or USB power
- On-board ST-LINK/V2-1 debugger/programmer with USB re-enumeration capability: Virtual COM port and debug port
- Comprehensive free software libraries and examples available with the [STM32CubeWB](#) MCU Package
- Support of a wide choice of Integrated Development Environments (IDEs) including IAR Embedded Workbench®, MDK-ARM, and STM32CubeIDE

Note:

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2 Ordering information

To order the STM32WB5MM-DK Discovery kit, refer to [Table 1](#). Additional information is available from the datasheet and reference manual of the target STM32.

Table 1. Ordering information

Order code	Board reference	Target STM32
STM32WB5MM-DK	MB1292	STM32WB5MMGH6

2.1 Codification

The meaning of the codification is explained in [Table 2](#).

Table 2. Codification explanation

STM32WBXXM-DK	Description	Example: STM32WB5MM-DK
STM32WB	MCU series in STM32 32-bit Arm Cortex MCUs	STM32WB Series
XX	MCU product line in the series	STM32WBxM Modules line (5M module version)
DK	Board type	Discovery kit

3 Development environment

3.1 System requirements

- Windows® OS (7, 8, or 10), Linux® 64-bit, or macOS®
- USB Type-A or USB Type-C® to Micro-B cable

Note: *macOS® is a trademark of Apple Inc. registered in the U.S. and other countries.*

Linux® is a registered trademark of Linus Torvalds.

All other trademarks are the property of their respective owners.

3.2 Development toolchains

- IAR Systems® - IAR Embedded Workbench®⁽¹⁾
 - Keil® - MDK-ARM⁽¹⁾
 - STMicroelectronics - STM32CubeIDE
1. *On Windows® only.*

3.3 Demonstration software

The demonstration software, included in the STM32Cube MCU Package corresponding to the onboard microcontroller, is preloaded in the STM32 Flash memory for easy demonstration of the device peripherals in standalone mode. The latest versions of the demonstration source code and associated documentation can be downloaded from www.st.com.

4 Conventions

Table 3 provides the conventions used for the ON and OFF settings in the present document.

Table 3. ON/OFF convention

Convention	Definition
Jumper JPx ON	Jumper fitted
Jumper JPx OFF	Jumper not fitted
Jumper JPx [1-2]	Jumper fitted between Pin 1 and Pin 2
Solder bridge SBx ON	SBx connections closed by 0 Ω resistor
Solder bridge SBx OFF	SBx connections left open
Resistor Rx ON	Resistor soldered
Resistor Rx OFF	Resistor not soldered

5 Safety recommendations

5.1 Targeted audience

This product target users with at least basic electronics or embedded software development knowledge like engineer, technician, or student.

This board is not a toy and is not suited for use by children.

5.2 Handling the board

This product contains a bare printed circuit board and as with all product of this type, the user must be careful about the following points:

- The connection pins on the board may be sharp, be careful when handling the board to avoid hurting yourself.
- This board content static sensitive devices. To avoid damaging it, handle the board in an ESD-proof environment.
- While powered, do not touch the electric connections on the board with fingers or anything conductive. The board operates at a voltage level that is not dangerous, but components may be damaged when shorted.
- Do not put any liquid on the board and avoid operating the board close to water or at a high humidity level.
- Do not operate the board if dirty or dusty.

6 Quick start

This section describes how to quickly start development using the STM32WB5MM-DK Discovery kit.

To use the product, the user must accept the Evaluation Product License Agreement from the www.st.com/epla webpage.

Before the first use, make sure that no damage occurred to the board during shipment:

- All socketed components are firmly secured in their sockets.
- No component is loose in the board blister.

The Discovery kit is an easy-to-use Discovery kit to quickly evaluate and start development with an STM32 microcontroller in an RF module package.

6.1 Getting started

1. Check jumper positions on board: JP1 and JP5 ON, JP2 (Power source) on USB MCU.
2. Install ST BLE Sensor Mobile Application on a BLE compatible mobile device from App Store or Google Play.
3. On the host PC any freeware or commercial audio recording software can be used to interface with the Discovery board. For example, Audacity® is an open-source, cross-platform program for recording and audio editing, available from <https://www.audacityteam.org/download>.
4. Connect the Discovery board to a PC with a USB cable Type-A to Micro-B through USB connector CN6 (USB USER). The board will be automatically recognized by Windows as a standard microphone (Found in “Windows device manager” as STM32 AUDIO Streaming in FS Mode). As soon as *BLE Advertising* appears on Discovery display, the board is ready to connect.
5. Use ST BLE sensor mobile application to detect the STM32WB5MM-DK (BVL-WB1) with ST Bluetooth® 00:80:E1:26:XX:XX device address and connect to it. The text *BLE Connected* appears on the Discovery board display, while the BlueVoice FullDuplex page is shown on the mobile application.
6. Pushing the B1 button on the board starts the audio acquisition and streaming from the Discovery on the application (*Audio TX* on the display), audio can be heard from the smartphone speaker.
7. Enabling the *Start* switch on the App starts audio streaming from the Smartphone to the Discovery (*Audio RX* on the display). Open Audacity on the host PC. To start an audio recording, check first if the audio input device is *STM32 AUDIO streaming* and then press the recording button. To listen to the received audio while recording, go to *Edit* □ *Preferences* □ *Recording* and check *Software playthrough of input*.
8. A full-duplex communication is performed if the streaming is enabled on both sides, “Full-duplex” message appears on Discovery display.
9. For more details refer to the user manual *Getting started with the STM32Cube function pack for STM32WB MCU featuring advanced audio streaming over Bluetooth 5.0 using Opus codec* (UM2614) of **FP-AUD-BVLINKWB1**, together with the demonstration software version v.2.0.0 or higher.

7 Hardware layout and configuration

The STM32WB5MM-DK Discovery kit is designed around the STM32W5MMG RF module that includes an STM32WB55VG Bluetooth® Low Energy microcontroller, a ceramic antenna, two crystals, and peripheral components. The hardware block diagram, shown in [Figure 2](#), illustrates the connections between the STM32W5MMG RF module and the peripheral components (Quad-SPI Flash memory, OLED display, USB OTG HS and FS connectors, USART, audio, ARDUINO® Uno V3, STMod+ shields, and embedded ST-LINK). [Figure 3](#) and [Figure 4](#) show the location of the main components on both sides of the Discovery board. [Figure 5](#) shows the STM32WB5MM-DK board mechanical dimensions.

Figure 2. STM32WB5MM-DK hardware block diagram

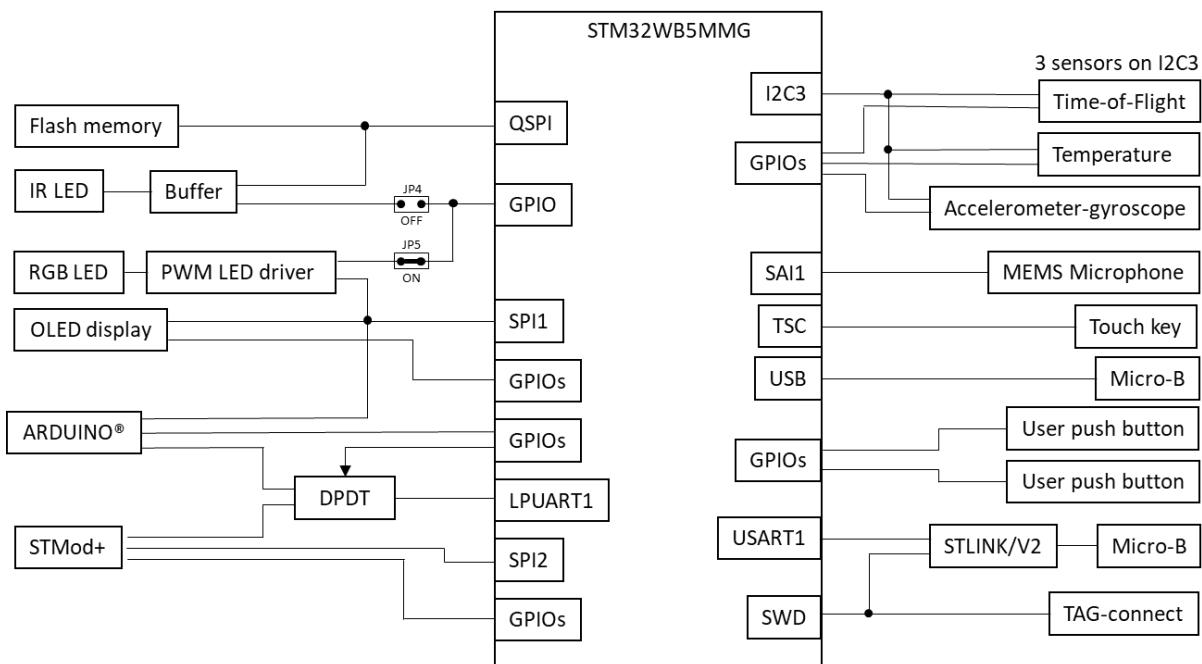


Figure 3. STM32WB5MM-DK PCB layout (top view)

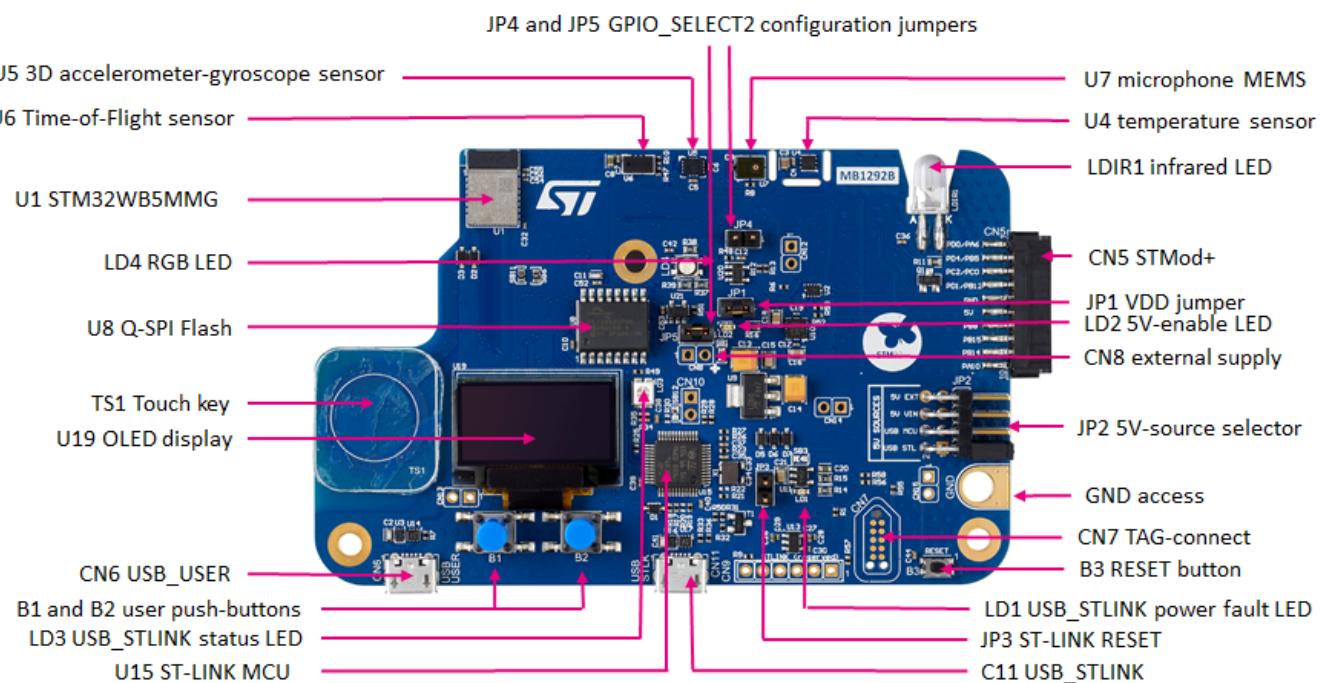


Figure 4. STM32WB5MM-DK PCB layout (bottom view)

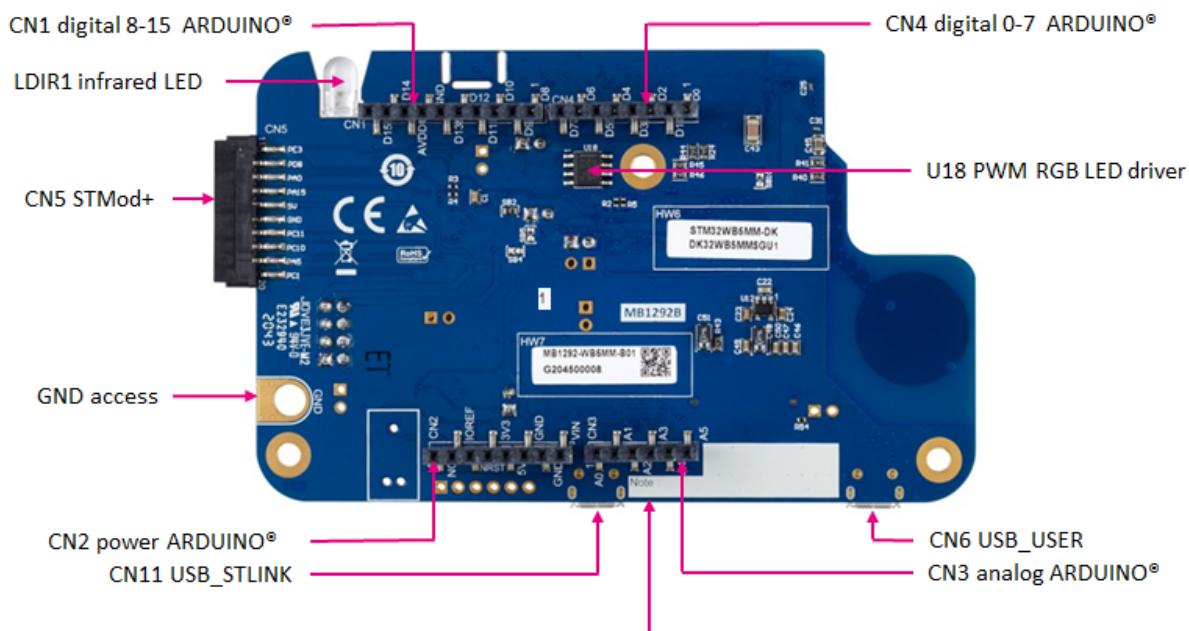
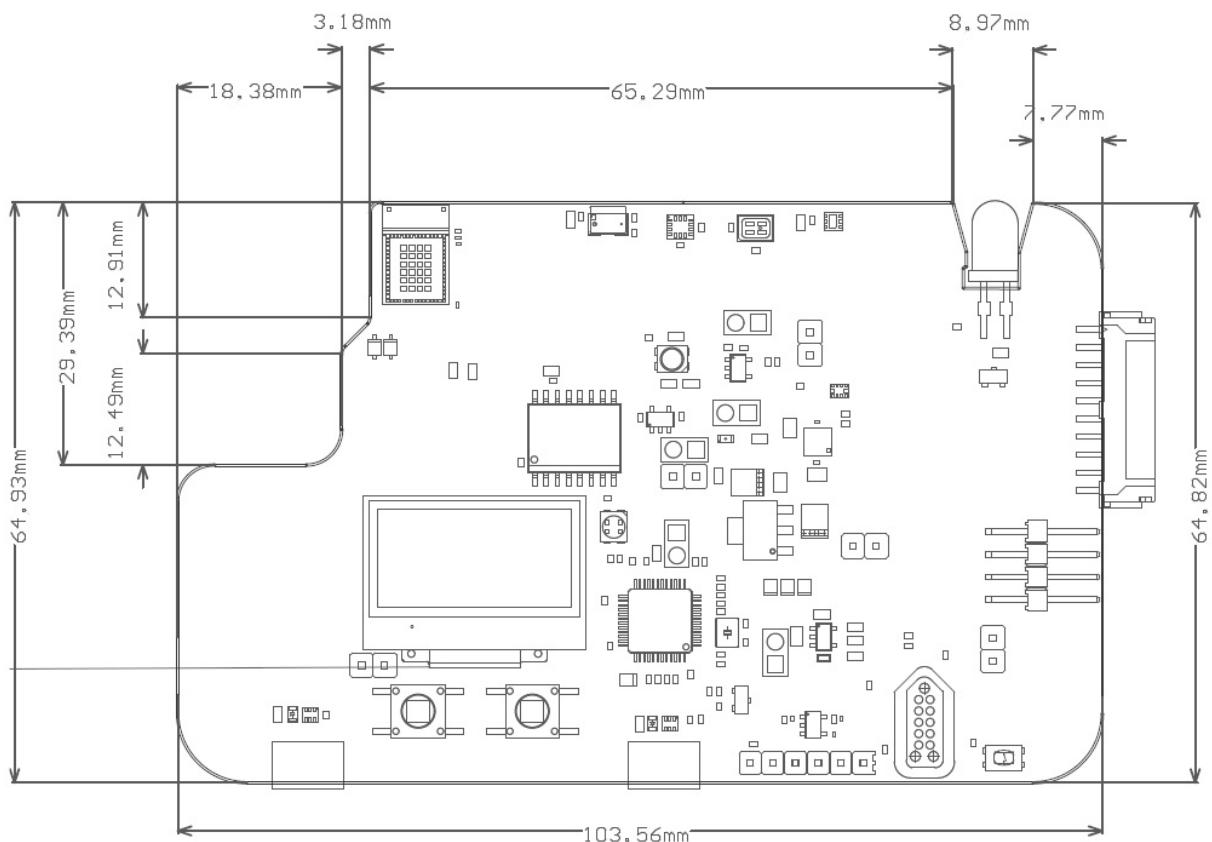


Figure 5. STM32WB5MM-DK board mechanical dimensions (top view, in millimeters)



7.1

Embedded ST-LINK/V2-1

The ST-LINK/V2-1 programming and debugging tool is integrated into the STM32WB5MM-DK Discovery kit. For information about debugging and programming features refer to *ST-LINK/V2 in-circuit debugger/programmer for STM8 and STM32 user manual (UM1075)*, which describes in detail all the ST-LINK/V2 features.

The additional features supported on the ST-LINK/V2-1 are:

- USB software re-enumeration
- Virtual COM port interface on USB
- Mass storage interface on USB
- USB power management request for more than 100 mA power on USB (limited to 300 mA for this board)

The following features are no more supported on the ST-LINK/V2-1:

- Application voltage lower than 3 V

7.1.1

Drivers

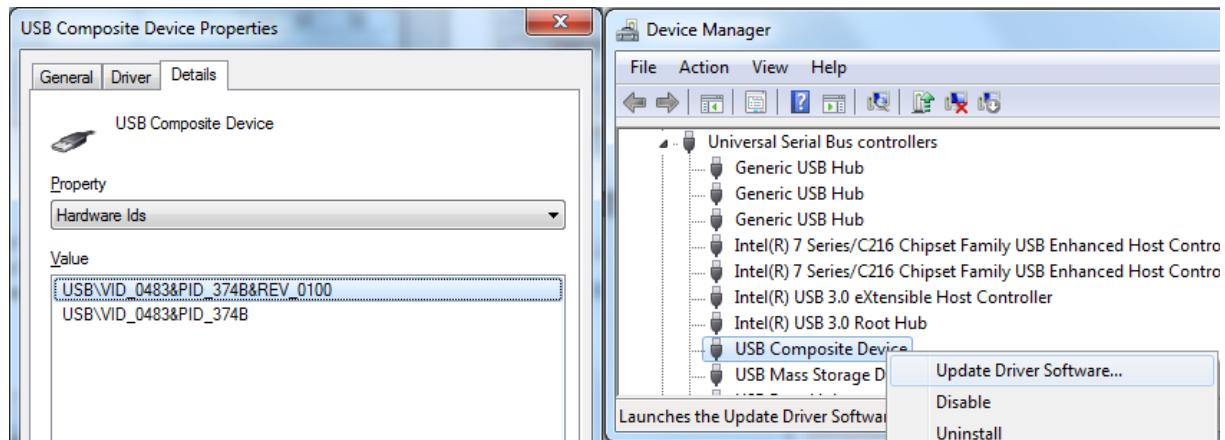
The ST-LINK/V2-1 requires a dedicated USB driver, which, for Windows 7® and Windows 8®, is found at www.st.com. For Windows 10®, it is not necessary to install the driver, as the ST-LINK is automatically identified.

In case the STM32WB5MM-DK Discovery kit is connected to the PC before the driver is installed, some Discovery board interfaces may be declared as “Unknown” in the PC device manager. In this case, the user must install the dedicated driver files, and update the driver of the connected device from the device manager as shown in Figure 6.

Note:

Prefer using the “USB Composite Device” handle for a full recovery.

Figure 6. USB composite device



7.1.2

ST-LINK/V2-1 firmware upgrade

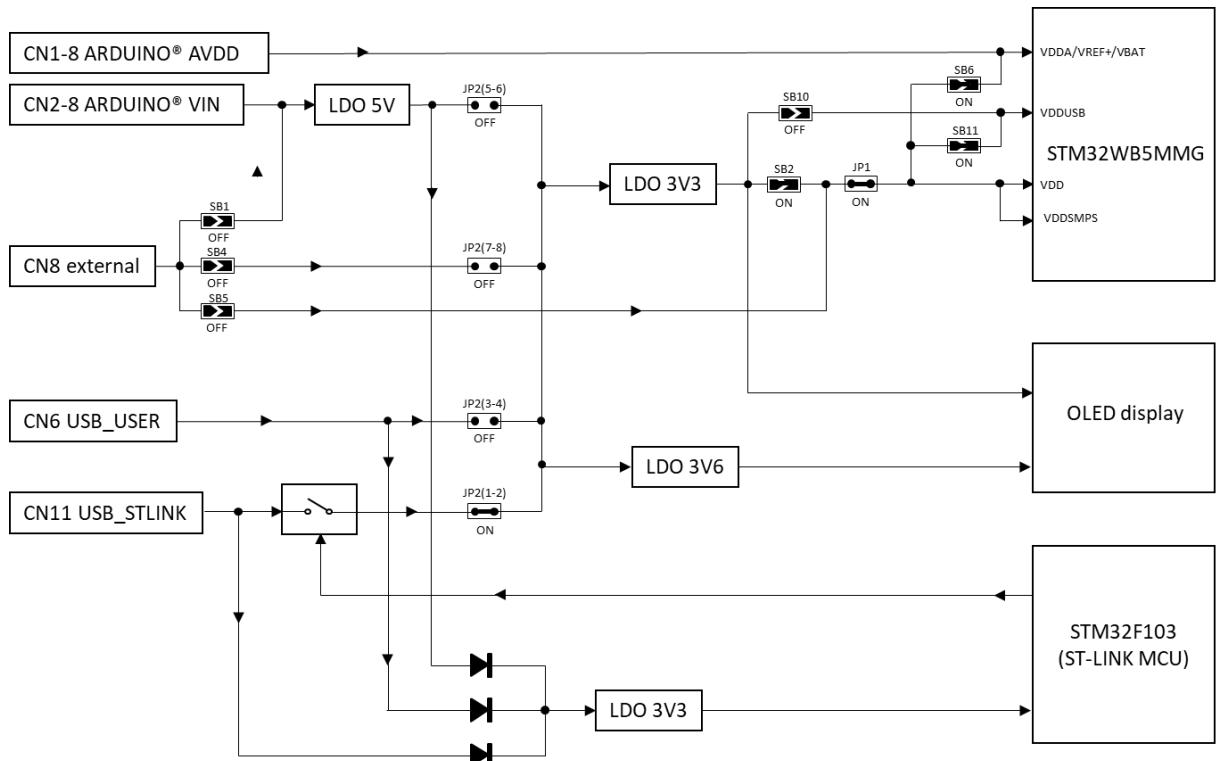
The ST-LINK/V2-1 embeds a firmware upgrade mechanism for the in-situ upgrade through the USB port. As the firmware may evolve during the lifetime of the ST-LINK/V2-1 product (for example new functionalities, bug fixes, support for new microcontroller families), it is recommended to visit the www.st.com website before starting to use the STM32WB5MM-DK Discovery kit and periodically, to stay up-to-date with the latest firmware version.

7.2 Power supply

7.2.1 General description

The STM32WB5MM module embedded on this STM32WB5MM-DK Discovery kit is always supplied by 3V3 but the board proposes a lot of possibilities to supply the module. The supply source can come from USB or ARDUINO® connectors, or from an external power supply. Figure 7 describes the board power tree. Moreover, this figure also shows the default state of the jumpers and solder bridges.

Figure 7. STM32WB5MM-DK power tree



7.2.2 7 to 12 V power supply

The STM32WB5MM-DK Discovery kit can be powered with a 7 to 12 V DC power source. There are two accesses for this type of levels:

- VIN pin of the CN2-8 ARDUINO® connector. It is possible to apply until +12 V on this pin or use an ARDUINO® shield which can deliver this type of voltage on the VIN pin.
- Ext input (CN8).

Caution:

In this case, paying attention to the configuration of the jumpers and solder bridges is very important. Verify this configuration on [Table 4](#).

These two sources are connected to a linear low drop voltage regulator (U9). The 5 V output of this regulator is a potential source of the 5V signal. Refer to [Section 7.2.3](#) for the details.

7.2.3

5 V power supply

The STM32WB5MM-DK Discovery kit can be powered by a 5 V DC power source. The 5V signal can come from several connectors:

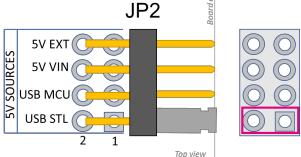
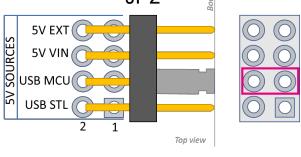
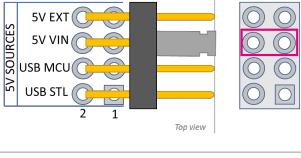
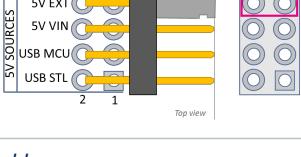
- 5V_USB_STLK connected to CN11 (default configuration for the supply of the board). This connector is dedicated to access to the STLINK/V2 and Virtual COM port and can supply power from the host computer. It is also possible to connect a USB charger to this connector. In this case, the ST-LINK and the Virtual COM port cannot be accessible.
- 5V_USB MCU connected to User USB. This USB port is directly connected to the STM32W5MMG as a USB port. The same remark applies as for 5V_USB-STLK, the supply can be provided by the host computer or by USB charger.
- Ext input (CN8). Be careful, in this case, the state of the jumpers and the solder bridges is very important. Refer to [Section 7.2.2](#) for details.
- 7-12V input through the U9 voltage regulator. Refer to [Section 7.2.2](#) for details.

The JP2 jumper JP2 selects the 5V source. [Table 4](#) shows the configuration for the selected source.

Caution:

Depending on the current needed on the devices connected to the USB port, and the board itself, power limitations can prevent the system from working as expected. The user must ensure that the STM32WB5MM-DK Discovery kit is supplied with an adequate power source depending on the needed current.

Table 4. JP2 power supply selector description

Jumper/solder bridge	Setting	Configuration ⁽¹⁾
JP2 5V supply source selector		STM32WB5MM-DK is supplied through the CN11 Micro-B USB receptacle (USB_STLINK).
		STM32WB5MM-DK is supplied through CN6 Micro-B receptacle (USB_USER).
		STM32WB5MM-DK is supplied through pin 8 of CN2 (ARDUINO®) or CN8 (Refer to the configuration details on the present power supply section).
		STM32WB5MM-DK is supplied through CN8 directly (Refer to the configuration details on the present power supply section).

1. The default configuration is in bold

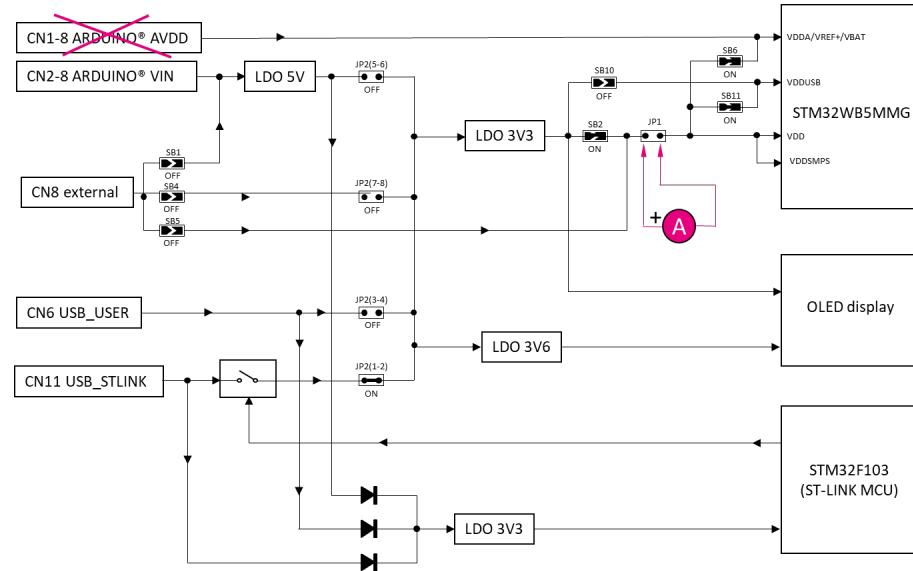
When 5V_USB_STLINK is used and JP2 [1-2] ON, the sequence is specific. In the beginning, only STM32F103 is supplied. If the USB enumeration succeeds, the 5V_USB_STLINK power is enabled by asserting the PWR_ENn signal from STM32F103CBT6. This pin is connected to an STMPS2141STR power switch which supplies the rest of the board. This power switch also features a current limitation to protect the PC in case of currents exceeding 300 mA.

7.2.4 Current measurement

As the device handles low-power features, it may be worth measuring the current consumed by the STM32WB5MMG module. To easily perform this measurement, there are two possibilities:

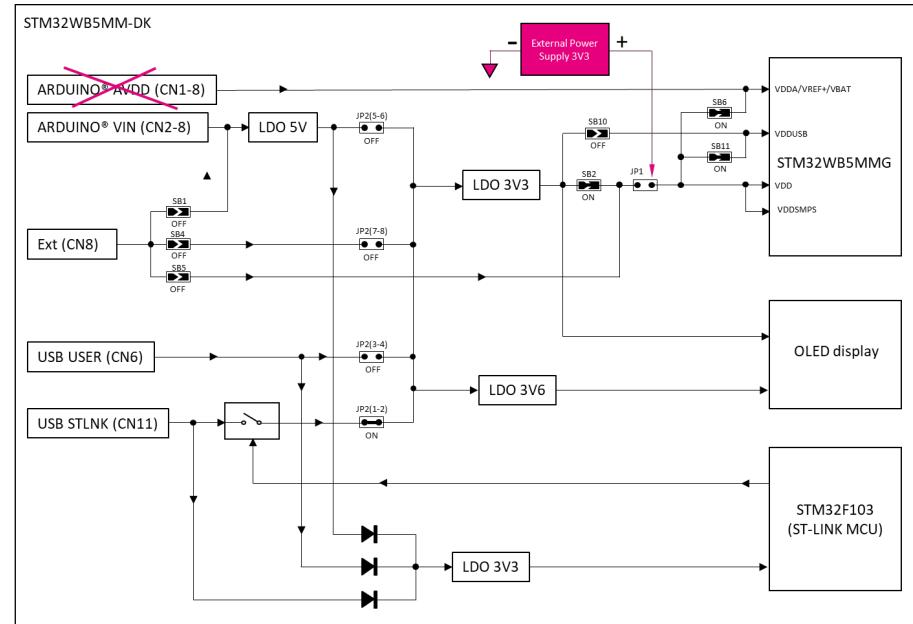
1. Measure the supply current of the STM32WB5MMG module using an ammeter in place of the JP1 jumper. In this case, all supply sources can be used except the AVDD coming from the ARDUINO® connector. [Figure 8](#) shows the configuration:

[Figure 8. Current measurement with an ammeter](#)



2. Or use an external power supply with current measurements capability. In this case, the JP1 jumper must be removed, and the supply must be connected to pin 2 of JP1, as shown in [Figure 9](#). The supply voltage must be 3.3 V and AVDD input (CN1-8) must not be used during this measurement.

[Figure 9. Current measurement with an external power supply](#)



7.3 Clock sources

7.3.1 HSE clock reference

The high-speed clock (HSE) of the STM32WB5MM-DK Discovery kit is embedded on the STM32W5MMG module. It uses a 32 MHz crystal oscillator. The HSE oscillator is trimmed during module manufacturing.

7.3.2 LSE clock reference

The low-speed clock (LSE) of the STM32WB5MM-DK Discovery kit is embedded on the STM32W5MMG module. It uses a 32.768 kHz crystal oscillator.

7.4 Reset sources

The reset signal of STM32W5MMG is active LOW. The internal pull-up resistor forces the RST signal to a HIGH level.

The sources of reset are the following:

- B3 push-button reset (small black button)
- Embedded ST-LINK/V2-1
- Pin 3 of the CN2 ARDUINO® connector, reset from the ARDUINO® board
- Pin 10 of the CN7 TAG-Connect (TAG10) connector

7.5 Board functions

7.5.1 128 × 64-pixel OLED display

The STM32WB5MM-DK board embeds the 9OL9935718000 OLED display from RiTdisplay Corporation. It is a 128 × 64-pixel OLED display panel matrix, with high contrast and SPI driven interface to display messages and user menus. The OLED panel matrix is controlled by an SSD1315Z embedded inside the display.

7.5.2 U8 Quad-SPI NOR Flash memory

The STM32WB5MM-DK board embeds a 128-Mbit Quad-SPI NOR Flash memory device (S25FL128SDSMFV001 from Cypress), which is connected to an STM32W5MMG dedicated Quad-SPI interface described in [Table 5](#).

Table 5. U8 Quad-SPI NOR Flash memory connection with STM32W5MMG

Quad-SPI memory pin number	Quad-SPI memory pin name	STM32W5MMG pin number	STM32W5MMG signal name
7	/CS	70 (PD3)	QSPI_BK_NCS
16	SCK	56 (PA3)	QSPI_BK_SCK
15	IO0	11 (PB9)	QSPI_BK_IO0
8	IO1	80 (PD5)	QSPI_BK_IO1
9	IO2	81 (PD6)	QSPI_BK_IO2
1	IO3	67 (PD7)	QSPI_BK_IO3

7.5.3 Virtual COM port

ST-LINK/V2-1 offers a USB Virtual COM port bridge. This feature allows access to the STM32W5MMG USART1 by the CN11 USB_STLINK connector.

By default, this STM32W5MMG USART1 interface is connected to the UART2 port of the STM32F103 ST-LINK/V2-1 MCU.

Table 6. UART interface pinout description

STM32W5MMG	CN10	STM32F103
USART1 RX (PB7/pin 18)	Pin 1	STLINK_TX: UART2 TX (PA2/pin 12)
USART1 TX (PB6/pin 39)	Pin 2	STLINK_RX: UART2 RX (PA3/pin 13)

7.5.4 MEMS microphone

The [IMP34DT05TR](#) MEMs microphone is connected through an SAI interface to the STM32W5MMG module. SAI1_CK2 and SAI1_DI2 are connected to the microphone and ensure the recording.

Table 7. IMP34DT05TR-STM32W5MMG SAI interface

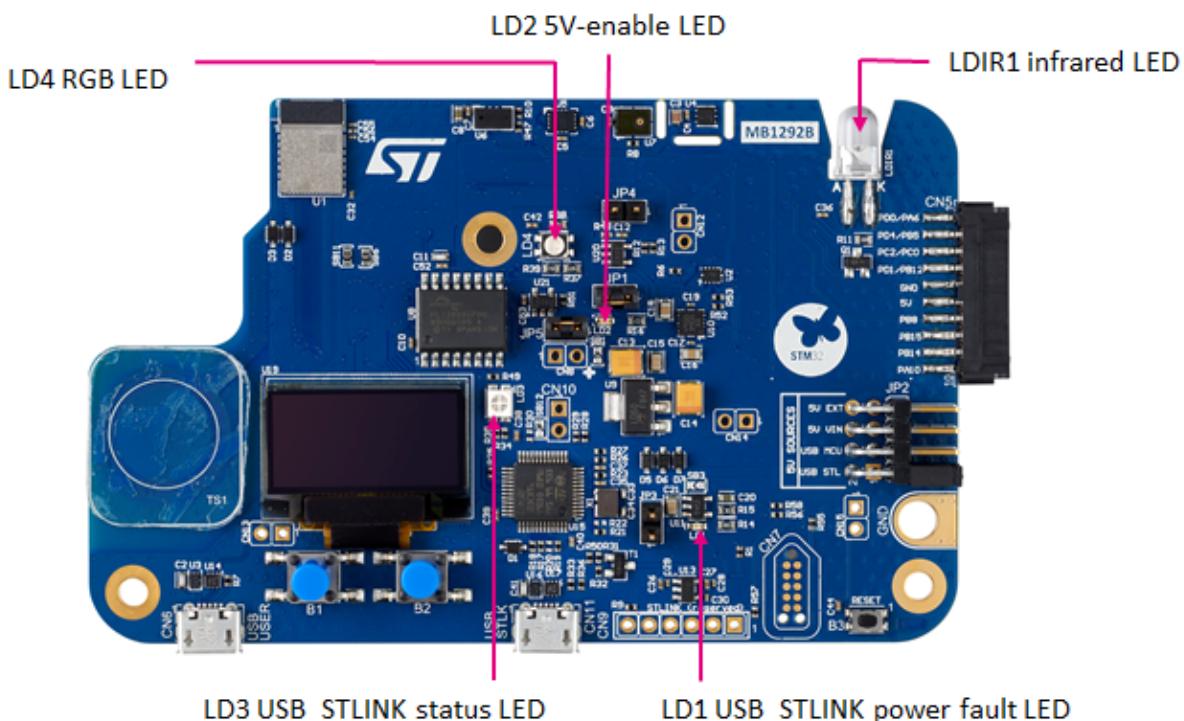
STM32W5MMG	IMP34DT05TR
SAI1_CK2 (PA8/pin 50)	CLK, Clock in (pin 3)
SAI1_DI2 (PA9/pin 51)	DOUT, PDM data out (pin 4)

7.5.5 LEDs

Description

Five LEDs on the top side of the STM32WB5MM-DK board help the user during the application development.

Figure 10. LEDs location



- LD1: this red LED indicates that the current distribution could not be performed as expected.
- LD2: this LED turns green when the 5 V is available. Refer to [Section 7.2.3](#) to select the 5 V source.
- LD3 COM: LD3 is a bi-color LED, which default status is red, turns to green to indicate that communication is in progress between the PC and the ST-LINK/V2-1, as follows:
 - Slow blinking red/OFF: at power-on, before USB initialization
 - Fast blinking red/OFF: after the first correct communication between PC and ST-LINK/V2-1 (enumeration)
 - Red ON: when initialization between PC and ST-LINK/V2-1 is successfully finished
 - Green ON: after successful target communication initialization
 - Blinking red/green: during communication with the target
 - Green ON: communication finished and OK
 - Orange ON: communication failure
- LD4: this LED is an RGB LED. It is available for the user application.
- LDIR1: this LED allows to transmit infrared radiation signal.

RGB LED

The resources coming from STM32W5MMG are shared between the RGB and IR LEDs. It is not possible to use them simultaneously. The selection is done by JP4 and JP5 jumpers.

To use the RGB LED, JP5 must be ON and JP4 OFF. In this configuration, GPIO_SELECT2 (PH1) is the chip select for this RGB device on SPI1.

The RGB LED is driven by the TLC59731 PWM LED driver from Texas Instruments.

Infrared (IR) LED

The resources coming from STM32W5MMG are shared between the RGB and IR LEDs. It is not possible to use them simultaneously. The selection is done by JP4 and JP5 jumpers.

To use the IR LED, JP4 must be ON and JP5 OFF. In this configuration, GPIO_SELECT2 (PH1) is the chip select for this IR transmission. PB9 is in charge of the IR modulation. This GPIO is shared with the Quad-SPI Flash Memory. It is possible to use the Flash Memory and IR LED on the same application but not exactly at the same time.

The IR LED is driven by TIM16 and TIM17 internal timers. The schematic proposal does not use the IR_OUT feature. A firmware example is available on the firmware package.

7.5.6 Push-buttons

Description

The STM32WB5MM-DK Discovery kit provides three buttons:

- B1 user push-button
- B2 user push-button
- B3 reset push-button, used to reset STM32WB5MM-DK Discovery kit.

Reset push-button

B3 is a small push-button dedicated to the hardware reset of the STM32WB5MM-DK. It is separated from the other push-buttons to avoid mishandling.

User push-buttons

There are two push-buttons available for the user application. They are connected to PC12 and PC13. It is possible to use them for GPIO reading or to wake up the device.

Table 8. Physical user interface I/O configuration (push-buttons)

Name	I/O	Available wake-up
B1 user1 push-button	PC12	WKUP3
B2 user2 push-button	PC13	WKUP2

7.5.7 Touch sensor

The STM32WB5MM-DK board embeds a touch sensor. The touch sensor is working with the charge and discharge of a capacitor. Touching the round panel with a finger charges a capacitor. Once the capacitor is charged at VDD, the charge is transferred to another capacitor, called the sampling capacitor.

Two groups of I/Os are connected to use it:

Table 9. Physical user interface I/O configuration (touch sensor)

I/O group	I/O	Configuration
Shield group 4	PC6	TSC_G4_IO1
	PC7	TSC_G4_IO2
Touch key group 6	PD10	TSC_G6_IO1
	PD11	TSC_G6_IO2

7.6 Embedded sensors

7.6.1 I²C interface

The STM32WB5MM-DK embedded sensors are connected to the STM32W5MMG module with an I²C bus. The Time-of-Flight (ToF), accelerometer/gyroscope, and temperature sensors are connected to STM32W5MMG I2C3 bus.

Table 10. STM32W5MMG I²C

STM32W5MMG port	Description
PB13 (pin 35)	I2C3_SCL
PB11 (pin 46)	I2C3_SDA

The address is a 7-bits address with an additional R/W bit (HIGH for reading, LOW for writing). describes the different address to R/W action for each component:

Table 11. Sensor I²C addresses

Device	Action	Address
ISM330DHCX (Accelerometer/gyroscope sensor)	Read	0b11010111 (D7h)
	Write	0b11010110 (D6h)
STTS22H (Temperature sensor)	Read	0b01110001 (71h)
	Write	0b01110000 (70h)
VL53L0CXV0DH/1 (Time-of-Flight sensor)	Read	0b01010011 (53h)
	Write	0b01010010 (52h)

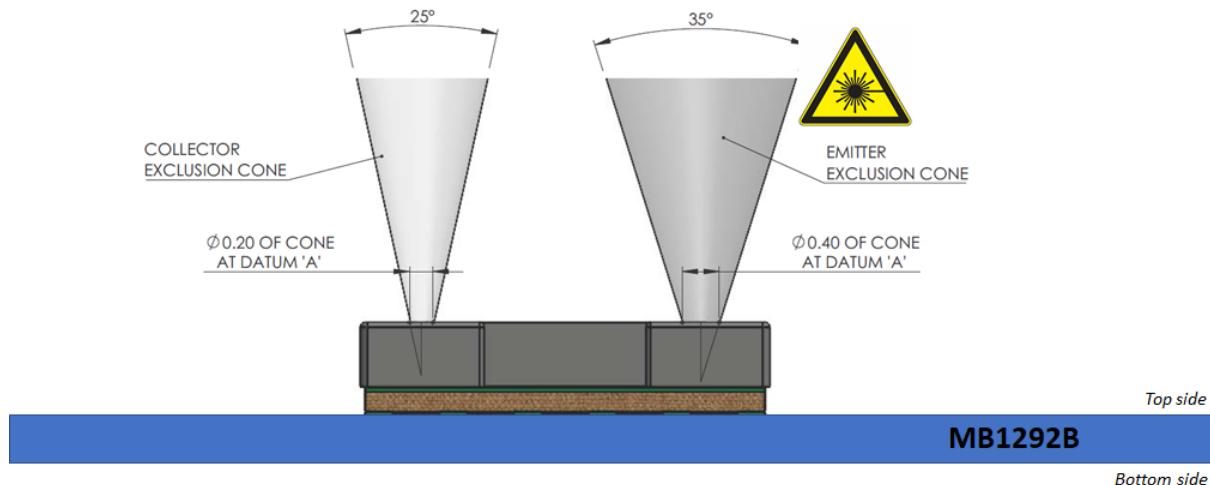
7.6.2

U6 Time-of-Flight (ToF) sensor

U6 [VL53L0CXV0DH/1](#) is a device that allows measuring the Time-of-Flight (ToF) of a laser beam. It is connected to the STM32W5MMG through the I²C interface.

This sensor can make a distance measurement and obstacle detection until two meters, and 1D-gesture recognition.

Figure 11. Direction, angle, and side operating



[VL53L0CXV0DH/1](#) contains a laser emitter and the corresponding drive circuitry. The laser output is designed to remain within Class 1 laser safety limits under all reasonably foreseeable conditions including single faults in compliance with IEC 60825-1:2014 (third edition). The laser output remains within Class 1 limits as long as the STMicroelectronics recommended device settings are used and the operating conditions specified in the STM32WB datasheets are respected. The laser output power must not be increased by any means and no optics used to focus the laser beam. Figure 12 shows the warning label for Class 1 laser products.

Figure 12. Class 1 laser product label



Table 12. U6 Time-of-Flight sensor I²C address

Device	Action	Address
VL53L0CXV0DH/1	Read	0b01010011 (53h)
	Write	0b01010010 (52h)

7.6.3 U5 3D accelerometer and 3D gyroscope sensor

U5 ISM330DHCX is connected to STM32W5MMG through the I²C interface.

[ISM330DHCX](#) is a system-in-package featuring a high-performance 3D digital accelerometer and 3D digital gyroscope tailored for Industry 4.0 applications.

Figure 13. 3D direction for acceleration and angular rate

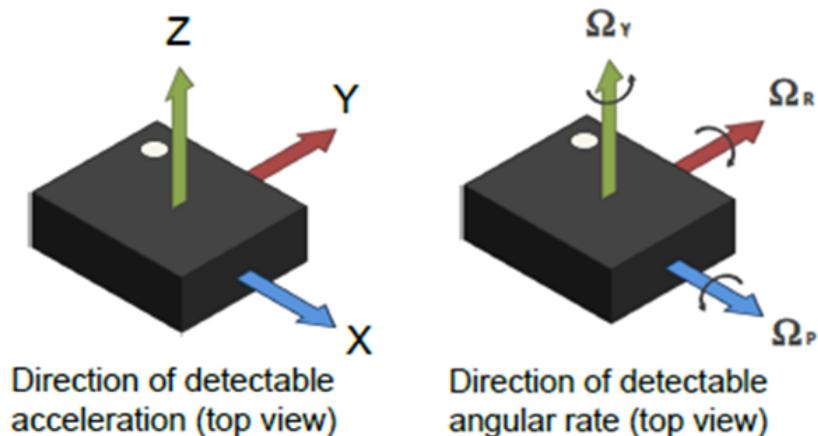


Figure 14. U5 ISM330DHCX pin 1 location

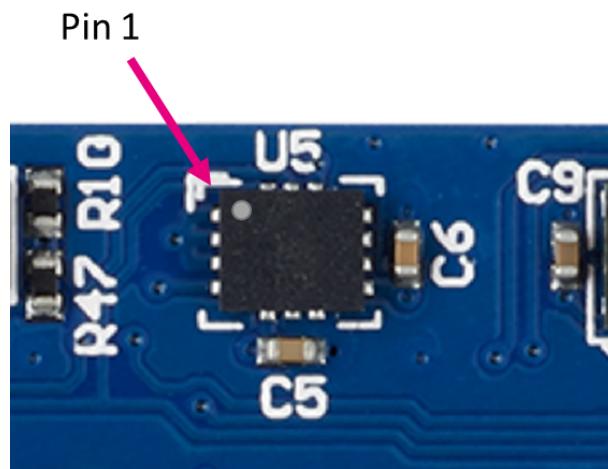


Table 13. U5 accelerator-gyroscope sensor I²C address

Device	Action	Address
ISM330DHCX	Read	0b11010111 (D7h)
	Write	0b11010110 (D6h)

7.6.4

U4 temperature sensor

U4 STTS22H is a device that measures the ambient temperature. It is connected to the STM32W5MMG through the I²C interface.

Table 14. U4 temperature sensor I²C address

Device	Action	Address
STTS22H	Read	0b01110001 (71h)
	Write	0b01110000 (70h)

8 Board connectors

The following connectors are implemented on the STM32WB5MM-DK board and described in the next subsections:

- CN11: ST-LINK/V2-1 USB Micro-B
- CN6: USB FS Micro-B
- CN5: STMod+
- CN7: TAG
- CN1, CN2, CN3, and CN4: ARDUINO® UnoV3

8.1 CN11 ST-LINK/V2-1 USB Micro-B connector

The main function of this connector is to connect the STM32WB5MM-DK embedded ST-LINK/V2-1 to the PC for programming and debugging purposes. It can supply the board (Refer to [Section 7.2 Power supply](#)).

The connector is a standard USB Micro-B connector.

The related pinout for the CN11 ST-LINK USB Micro-B connector is listed in [Table 15](#).

Table 15. CN11 USB Micro-B connector pinout

Pin number	Pin name	Signal name	Function
1	VBUS	5V_USB_ST_LINK	V _{BUS} power
2	DM	USB_STLK_N	DM
3	DP	USB_STLK_P	DP
4	ID	-	-
5	GND	GND	Ground

8.2 CN6 USB FS Micro-B connector

The STM32W5MMG module handles a USB Full Speed peripheral, available on the CN6 USB Micro-B connector. It can communicate with a USB host as a USB device and can supply the board. Refer to [Section 7.2](#) for more details.

The related pinout of the CN6 USB Micro-B connector is listed in [Table 16](#).

Table 16. CN6 USB Micro-B connector pinout

Pin number	Pin name	Signal name	Function
1	VBUS	5V_USB MCU	V _{BUS} power
2	DM	USB_N	DM
3	DP	USB_P	DP
4	ID	-	-
5	GND	GND	Ground

8.3 CN5 STMod+ connector

The CN5 STMod+ standard connector is on the STM32WB5MM-DK board to support flexibility in small form factor application.

Figure 15 shows the pinout of the STMod+ connector.

Caution: Check the orientation before plugging the fan-out or extension board. An error of orientation can generate important damage on the STM32WB5MM-DK and the plugged board.

Figure 15. CN5 STMod+ connector

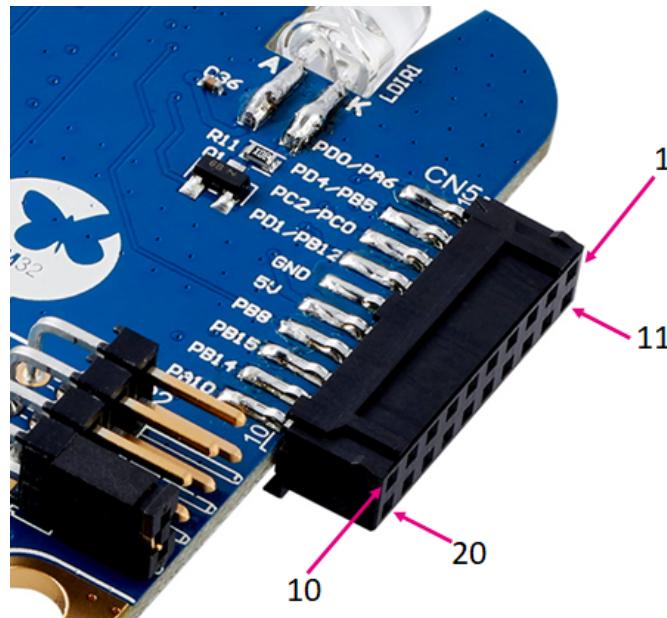


Figure 16. Top silkscreen STMod+ connector

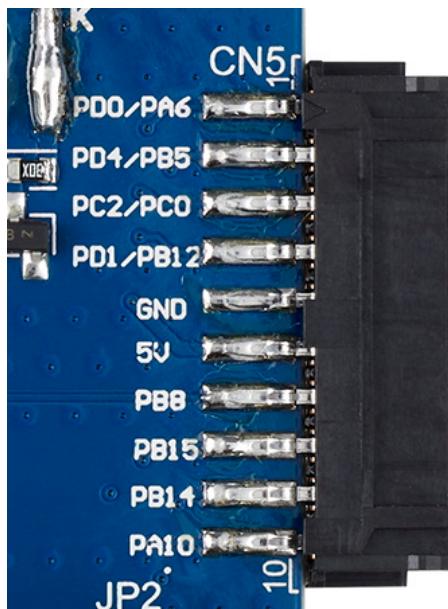


Figure 17. Bottom silkscreen STMod+ connector

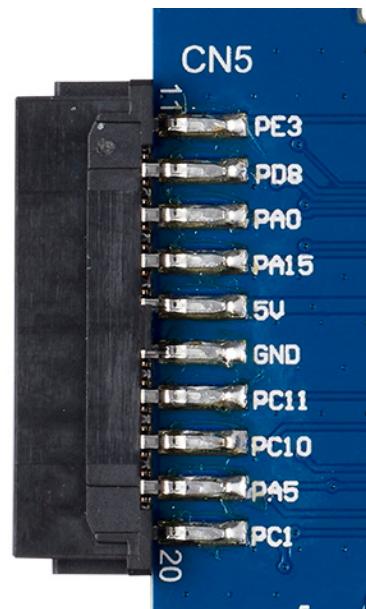


Table 17. CN5 STMod+ connector pinout

Pin number	STM32W5MMG pin	Function
1	PD0	SPI2_NSS
	PA6	LPUART1_CTS
2	PD4	SPI2_MOSI (1)
	PB5	LPUART1_TXD
3	PC2	SPI2_MISO (1)
	PC0	LPUART1_RXD
4	PD1	SPI2_SCK
	PB12	LPUART1_RTS
5	GND	Ground
6	+5V	Power
7	PB8	I2C1_SCL
8	PB15	SPI2_MOSI (2)
9	PB14	SPI2_MISO (2)
10	PA10	I2C1_SDA
11	PE3	INT
12	PD8	STMOD+_RESET
13	PA0	ADC1_IN5
14	PA15	PWM (TIM2_CH1)
15	+5V	Power
16	GND	Ground
17	PC11	GPIO
18	PC10	GPIO
19	PA5	GPIO ADC1_IN10
20	PC1	GPIO ADC1_IN12

8.4

CN7 TAG10 TAG-Connect

Section 7.1 presents the ST-LINK default debugging and programming tool. However, it is possible to use another debugging and programming tool through the CN7 TAG-Connect in its TAG10 10-pin version.

Figure 18. CN7 TAG-Connect pinout

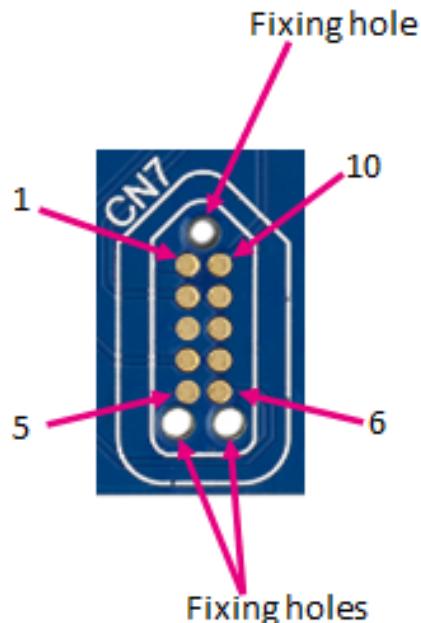


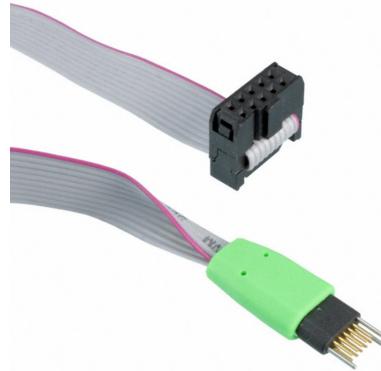
Table 18. CN7 connector pinout

Pin number	Pin name	Signal name	STM32W5MMG pin	Function
1	3V3_STLK	3V3	-	Reference level
2	TAG_SWDIO	SWDIO	PA13	Serial wire data I/O
3	GND	-	-	Ground
4	TAG_SWCLK	SWCLK	PA14	Serial wire clock
5	GND	-	-	Ground
6	TAG_SWO	SWO	PB3	Serial wire output
7	NC	-	-	-
8	NC	-	-	-
9	NC	-	-	-
10	TAG_NRST	/Reset	NRST	Reset

If the TAG-Connect is used, it is very important to disable the embedded ST-LINK to avoid signal conflict between this ST-LINK and the external tool. To disable the embedded ST-LINK, it is only necessary to set the STM32F103 in reset mode, with JP3 jumper ON.

To benefit from this connection, it is necessary to use the TC2050-IDC-NL accessory cable shown in Figure 19.

Figure 19. TC2050-IDC-NL cable

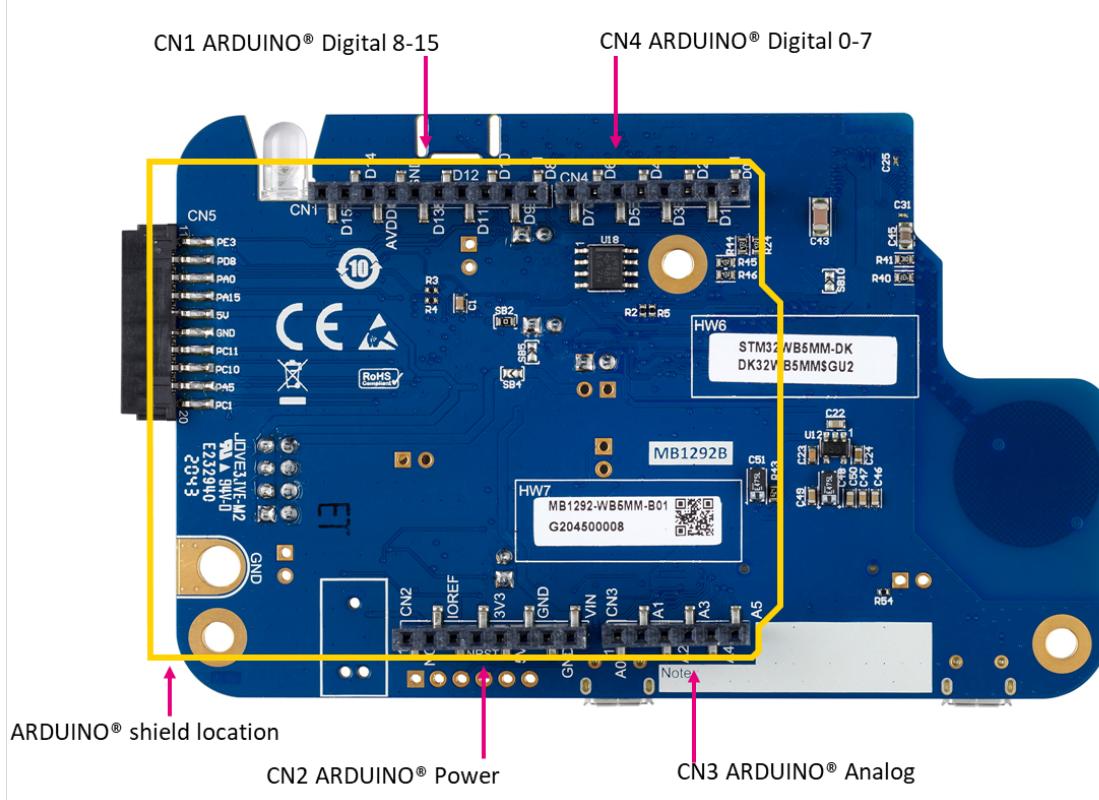


8.5 CN1, CN2, CN3, and CN4 ARDUINO® Uno V3 connectors

8.5.1 Description

ARDUINO® Uno V3 extension socket is located on the bottom side of the board. It is built around CN1, CN2, CN3 and CN4 standard connectors. Most shields designed for ARDUINO® can fit with Discovery kits to offer flexibility in small form factor applications.

Figure 20. ARDUINO® Uno connectors and ARDUINO® shield location



8.5.2 ARDUINO® operating voltage

The ARDUINO® Uno V3 connectors support 5 V, 3.3 V, and VDD for I/O compatibility.

Warning:

Do not supply 3.3 V or 5 V from the ARDUINO® shield. Supplying 3.3 V or 5 V from the ARDUINO® shield could damage the STM32WB5MM-DK Discovery kit.

Furthermore, if it is necessary to supply the STM32WB5MM-DK board with the ARDUINO® connector, VIN dedicated pin is available to directly supply the board. For more information on this feature, refer to Section 7.2.2 7 to 12 V power supply.

8.5.3 ARDUINO® interface and pinout

Figure 21 shows the position of the ARDUINO® shield when it is plugged on STM32WB5MM-DK with the pinout. The pinout showed on this figure corresponding to standard ARDUINO® naming. To find the correspondence with the STM32, refer to Table 19.

Figure 21. ARDUINO® pinout location

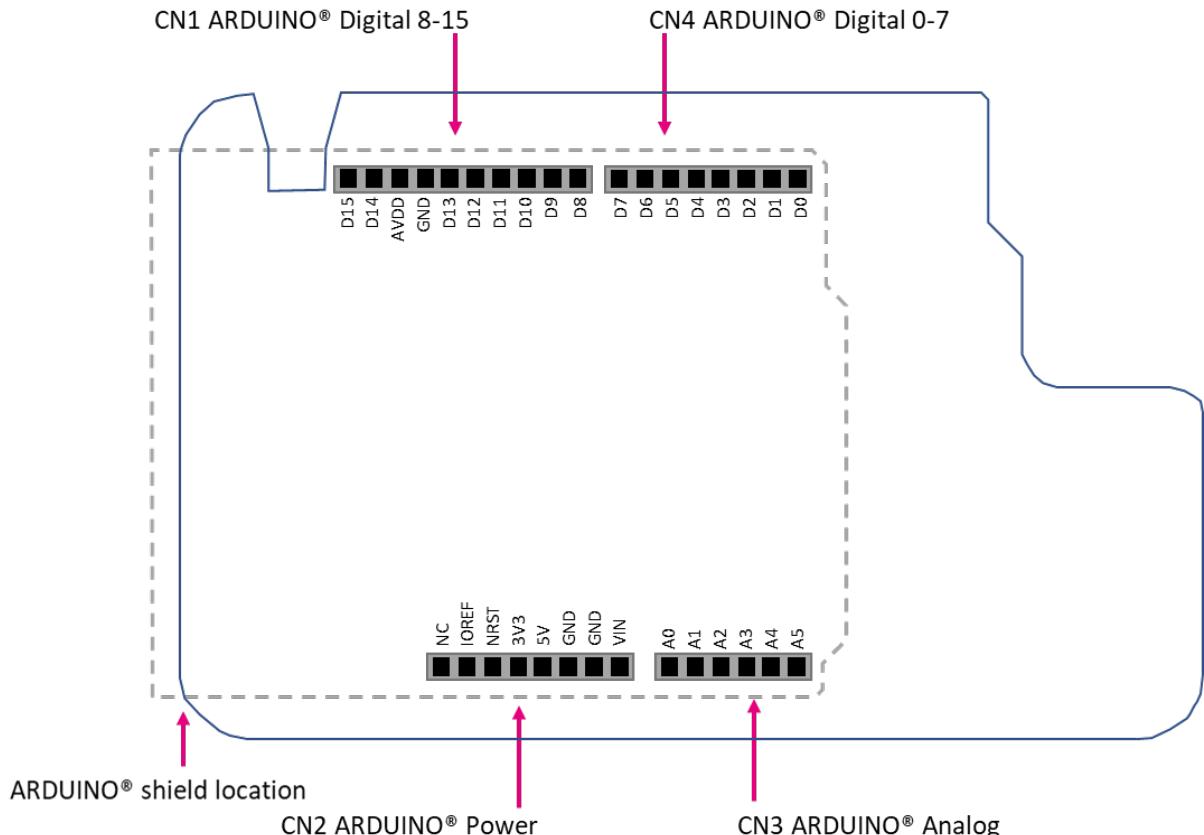


Table 19. ARDUINO® connector pinout

Connector	Pin name	Signal name	STM32W5MMG pin	Comment
CN2	1	NC	-	NC (reserved for the test)
	2	3V3 (IOREF)	-	IOREF 3V3
	3	NRST	NRST	NRST
	4	3V3	-	3.3 V
	5	5V	-	5 V
	6	GND	-	Ground
	7	GND	-	Ground
	8	VIN		External Supply Input (+12V)
CN3	1	A0	PC3	ADC1_IN4
	2	A1	PA2	ADC1_IN7
	3	A2	PA5	ADC1_IN10
	4	A3	PC1	ADC1_IN2
	5	A4	PC4	ADC1_IN13
	6	A5	PC5	ADC1_IN14
CN4	1	ARD_D0	PC0	LPUART1_RX
	2	ARD_D1	PB5	LPUART1_TX
	3	ARD_D2	PD12	GPIO
	4	ARD_D3	PD14	GPIO/TIM1_CH1
	5	ARD_D4	PE3	GPIO
	6	ARD_D5	PB10	GPIO/TIM2_CH3
	7	ARD_D6	PE0	GPIO/TIM16_CH1
	8	ARD_D7	PB2	GPIO
CN1	1	ARD_D8	PD13	GPIO
	2	ARD_D9	PD15	GPIO/TIM1_CH2
	3	ARD_D10	PA4	SPI1_NSS
	4	ARD_D11	PA7	SPI1_MOSI/TIM17_CH1
	5	ARD_D12	PB4	SPI1_MISO
	6	ARD_D13	PA1	SPI1_SCK
	7	GND	-	Ground
	8	AVDD	-	VDDA
	9	ARD_D14	PA10	I2C1_SDA
	10	ARD_D15	PB8	I2C1_SCL

9 STM32WB5MM-DK board information

9.1 Product marking

The stickers located on the top or bottom side of the PCB provide product information:

- Product order code and product identification for the first sticker
- Board reference with revision, and serial number for the second sticker

On the first sticker, the first line provides the product order code, and the second line the product identification.

On the second sticker, the first line has the following format: "MBxxxx-Variant-yzz", where "MBxxxx" is the board reference, "Variant" (optional) identifies the mounting variant when several exist, "y" is the PCB revision and "zz" is the assembly revision, for example B01. The second line shows the board serial number used for traceability.

Evaluation tools marked as "ES" or "E" are not yet qualified and therefore not ready to be used as reference design or in production. Any consequences deriving from such usage will not be at ST charge. In no event, ST will be liable for any customer usage of these engineering sample tools as reference designs or in production.

"E" or "ES" marking examples of location:

- On the targeted STM32 that is soldered on the board (For an illustration of STM32 marking, refer to the STM32 datasheet "Package information" paragraph at the www.st.com website).
- Next to the evaluation tool ordering part number that is stuck or silk-screen printed on the board.

Some boards feature a specific STM32 device version, which allows the operation of any bundled commercial stack/library available. This STM32 device shows a "U" marking option at the end of the standard part number and is not available for sales.

In order to use the same commercial stack in his application, a developer may need to purchase a part number specific to this stack/library. The price of those part numbers includes the stack/library royalties.

9.2 STM32WB5MM-DK product history

9.2.1 Product identification DK32WB5MM\$GU1

This product identification is based on the MB1292-WB5MM-B01 board.

It embeds the [STM32W5MMG](#) module with revision code "1". The limitations of this revision are detailed in the errata sheet [STM32WB5MMG module product errata \(ES0525\)](#).

Product limitations

No limitation identified for this product identification.

9.3 Board revision history

9.3.1 Board MB1292 revision B-01

The revision B-01 is the initial release of the MB1292 board.

Board limitations

No limitation identified for this board revision.

Appendix A STM32WB5MM-DK I/O assignment

Table 20. STM32WB5MM-DK I/O assignment

Pin number	Pin name	Assignment on STM32WB5MM-DK
1	PA2	ADC1_IN7 (ARDUINO® A1)
2	PA1	SPI1_SCK (ARDUINO® D13)
3	PA0	ADC1_IN5 (STMod+ pin 13)
7	PC3	ADC1_IN4 (ARDUINO® A0)
8	PC2	SPI2_MISO (STMod+ pin 3)
9	PC1	ADC1_IN2 (STMod+ pin 20 and ARDUINO® A3)
11	PB9	QUADSPI_BK1_IO0 or IR LED control
12	PC0	LPUART1_RX (STMod+ pin 3 and ARDUINO® D0)
13	PH3-BOOT0	BOOT0 (Pull-down by default, connected to CN13)
14	PB8	I2C1_SCL (STMod+ pin 7 and ARDUINO® D15)
18	PB7	USART1_RX (VCP ST-LINK)
19	PB5	LPUART1_TX (STMod+ pin 2 and ARDUINO® D1)
20	PB4	SPI1_MISO (SPI OLED display, ARDUINO® D11)
21	PB3	SWO (ST-LINK)
22	PC10	GPIO (STMod+ pin18)
23	PC11	GPIO (STMod+ pin 17)
24	PC12	User push-button B1 (WKUP3)
25	PA13	SWDIO (ST-LINK)
26	PA14	SWCLK (ST-LINK)
27	PA15	TIM2_CH1/PWM (STMod+ pin 14)
28	PA10	I2C1_SDA (STMod+ pin 10 and ARDUINO® D14)
29	PA12	USB_DP
30	PA11	USB_DM
33	PD0	SPI2_NSS (STMod+ pin 1)
34	PD1	SPI2_SCK (STMod+ pin 4)
35	PB13	I2C3_SCL (MEMS sensors)
36	PC6	TSC_G4_IO1 (Touch key)
37	PB14	SPI2_MISO (STMod+ pin 9)
38	PB15	SPI2_MOSI (STMod+ pin 8)
39	PB6	USART1_TX (VCP ST-LINK)
40	PC13	User push-button B2 (WKUP2)
41	PB12	LPUART1_RTS (STMod+ pin 4)
42	PE4	GPIO (ARDUINO® D4)
45	PC5	ADC1_IN14 (ARDUINO® A5)
46	PB11	I2C3_SDA (MEMS sensors)
47	PB10	TIM2_CH3 (ARDUINO® D5)

Pin number	Pin name	Assignment on STM32WB5MM-DK
48	PB2	GPIO (ARDUINO® D7)
49	PC4	ADC1_IN13 (ARDUINO® A4)
50	PA8	SAI1_CK2 (Digital microphone)
51	PA9	SAI1_DI2 (Digital microphone)
52	PA7	SPI1_MOSI (SPI OLED display/ ARDUINO® D1/ RGB LED driver) *
53	PA6	LPUART_CTS (STMod+ pin 1)
54	PA5	ADC1_IN10 (STMod+ pin 19 and ARDUINO® D10)
55	PA4	SPI1_NSS (ARDUINO® D10)
56	PA3	QUADSPI_SCLK (Quad-SPI Flash memory)
61	PH0	SPI1_NSS (SPI chip select of OLED display)
62	PH1	GPIO_SELECT2 (RGB LED/Infrared LED)
63	PD14	TIM_CH1 (ARDUINO® D3)
64	PE1	DRDY (STTS22H temperature sensor)
65	PD13	GPIO (ARDUINO® D8)
66	PD12	GPIO (ARDUINO® D2)
67	PD7	QUADSPI_BK1_IO3 (Quad-SPI Flash memory)
68	PD2	INT signal for accelerometer/gyroscope sensor
69	PC9	D/C_DISP (Data or Ctrl OLED display)
70	PD3	QUADSPI_BK1_NCS (Quad-SPI Flash memory)
71	PC7	TSC_G4_IO2 (Touch key)
72	PE3	INT STMod+ (STMod+ pin 11)
73	PD4	SPI2_MOSI (STMod+ pin2)
74	PD9	INT signal for Time-of-Flight sensor
75	PD8	STMod+ RESET (STMod+ pin 12)
76	PD15	TIM1_CH2 (ARDUINO® D9)
77	PD10	TSC_G6_IO1 (Touch key)
78	PE2	GPIO_SELECT1 (Ctrl switch LPUART)
79	PE0	TIM16_CH1 (ARDUINO® D6)
80	PD5	QUADSPI_BK1_IO1 (Quad-SPI Flash memory)
81	PD6	QUADSPI_BK1_IO2 (Quad-SPI Flash memory)
82	PD11	TSC_G6_IO2 (Touch key)
83	PC8	RST_DISP (Reset OLED display)

Appendix B Federal Communications Commission (FCC)

Identification of products: STM32WB5MM-DK.

Contains certified module from STMicroelectronics: STM32W5MMG

FCC ID: YCP-STM32WB5M01

Part 15.19

This device complies with Part 15 of the FCC Rules. Operation is subject to the following two conditions: (1) this device may not cause harmful interference, and (2) this device must accept any interference received, including interference that may cause undesired operation.

Part 15.21

Any changes or modifications to this equipment not expressly approved by STMicroelectronics may cause harmful interference and void the user's authority to operate this equipment.

Part 15.105

This equipment has been tested and found to comply with the limits for a Class B digital device, pursuant to part 15 of the FCC Rules. These limits are designed to provide reasonable protection against harmful interference in a residential installation. This equipment generates uses and can radiate radio frequency energy and, if not installed and used in accordance with the instruction, may cause harmful interference to radio communications. However, there is no guarantee that interference will not occur in a particular installation. If this equipment does cause harmful interference to radio or television reception which can be determined by turning the equipment off and on, the user is encouraged to try to correct interference by one or more of the following measures:

- Reorient or relocate the receiving antenna.
- Increase the separation between the equipment and receiver.
- Connect the equipment into an outlet on circuit different from that to which the receiver is connected.
- Consult the dealer or an experienced radio/TV technician for help.

This device complies with FCC RF radiation exposure limits set forth for general population. This device must be installed to provide a separation distance of at least 20 centimeters from all persons and must not be co-located or operating in conjunction with any other antenna or transmitter.

Responsible party (in the USA)

Terry Blanchard

Americas Region Legal | Group Vice President and Regional Legal Counsel, The Americas
STMicroelectronics, Inc.

750 Canyon Drive | Suite 300 | Coppell, Texas 75019
USA

Telephone: +1 972-466-7845

Appendix C Innovation, Science and Economic Development (ISED) Canada Compliance Statements

This radio transmitter (8976A-STM32WB5M01) has been approved by ISED Canada to operate with the antenna types listed below with the maximum permissible gain and required antenna impedance for each antenna type indicated. Antenna types not included in this list, having a gain greater than the maximum gain indicated for that type, are strictly prohibited for use with this device.

Le présent émetteur radio (8976A-STM32WB5M01) a été approuvé par ISED Canada pour fonctionner avec les types d'antenne énumérés ci-dessous et ayant un gain admissible maximal et l'impédance requise pour chaque type d'antenne. Les types d'antenne non inclus dans cette liste, ou dont le gain est supérieur au gain maximal indiqué, sont strictement interdits pour l'exploitation de l'émetteur.

Compliance Statement

Notice: This device complies with ISED Canada licence-exempt RSS standard(s). Operation is subject to the following two conditions: (1) this device may not cause interference, and (2) this device must accept any interference, including interference that may cause undesired operation of the device.

ISED Canada ICES-003 Compliance Label: CAN ICES-3 (B) / NMB-3 (B).

Déclaration de conformité

Avis: Le présent appareil est conforme aux CNR d'ISDE Canada applicables aux appareils radio exempts de licence. L'exploitation est autorisée aux deux conditions suivantes : (1) l'appareil ne doit pas produire de brouillage, et (2) l'utilisateur de l'appareil doit accepter tout brouillage radioélectrique subi, même si le brouillage est susceptible d'en compromettre le fonctionnement.

Étiquette de conformité à la NMB-003 d'ISDE Canada : CAN ICES-3 (B) / NMB-3 (B).

RF exposure statement

This device complies with ISED radiation exposure limits set forth for general population. This device must be installed to provide a separation distance of at least 20 centimeters from all persons and must not be co-located or operating in conjunction with any other antenna or transmitter.

Le présent appareil est conforme aux niveaux limites d'exigences d'exposition RF aux personnes définies par ISDE. L'appareil doit être installé afin d'offrir une distance de séparation d'au moins 20 centimètres avec les personnes et ne doit pas être installé à proximité ou être utilisé en conjonction avec une autre antenne ou un autre émetteur.

Appendix D Radio Equipment Directive (RED) compliance statement

Déclaration de conformité CE simplifiée :

STMicroelectronics déclare que l'équipement radioélectrique du type STM32WB5MM-DK est conforme à la directive 2014/53/UE.

Bandes de fréquence utilisées en transmission et puissance maximale rayonnée dans cette bande :

- Bande de fréquence : 2400-2483.5 MHz (Bluetooth®)
- Puissance maximale : 4 mW p.i.r.e

Simplified EC compliance statement:

Hereby, STMicroelectronics declares that the radio equipment type STM32WB5MM-DK is in compliance with Directive 2014/53/EU.

Frequency range used in transmission and maximal radiated power in this range:

- Frequency range: 2400-2483.5 MHz (Bluetooth®)
- Maximal power: 4 mW e.i.r.p

Revision history

Table 21. Document revision history

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23-Apr-2021	1	Initial release.

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